September 2001

FDC638P

P-Channel 2.5V PowerTrench[®] Specified MOSFET

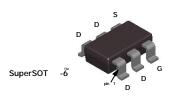
General Description

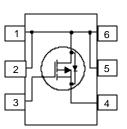
This PChannel 2.5V specified MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance

These devices are well suited for battery power applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- -4.5 A, -20 V. $R_{DS(ON)}$ = 48 m Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 65 m Ω @ V_{GS} = -2.5 V
- Low gate charge (10 nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- SuperSOT [™] –6 package: small footprint (72% smaller than standard SO-8; low profile (1mm thick)





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
l _D	Drain Current – Continuous	(Note 1a)	-4.5	А
	– Pulsed		-20	
PD	Power Dissipation for Single Operation	(Note 1a)	1.6	w
		(Note 1b)	0.8	VV
T _J , T _{STG}	Operating and Storage Junction Temperatu	re Range	-55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity	
.638	.638 FDC638P 7"		8mm	3000 units	

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FDC638P

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$l_D = -250 \ \mu\text{A}, \text{Referenced to } 25^\circ\text{C}$		-14		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-0.4	-0.8	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{\rm GS} = -4.5 \ V, & I_{\rm D} = -4.5 \ A \\ V_{\rm GS} = -2.5 \ V, & I_{\rm D} = -3.8 \ A \\ V_{\rm GS} = -4.5 \ V, \ I_{\rm D} = -4.5 \ T_{\rm J} = 125^{\circ} C \end{array} $		39 52 54	48 65 72	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = -4.5 \text{ V}, \qquad V_{DS} = -5 \text{ V}$	-20			А
g fs	Forward Transconductance	$V_{DS} = -10 V$, $I_D = -4.5 A$		15		S
Dvnamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		1160		pF
Coss	Output Capacitance	f = 1.0 MHz		195		pF
Crss	Reverse Transfer Capacitance			105		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -5 V$, $I_D = -1 A$,		12	22	ns
tr	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		9	18	ns
t _{d(off)}	Turn–Off Delay Time			33	53	ns
t _f	Turn–Off Fall Time			12	22	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -4.5 A$,		10	14	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		2.2		nC
Q _{gd}	Gate-Drain Charge			1.5		nC
Drain-Se	ource Diode Characteristics a	and Maximum Ratings		1		
ls	Maximum Continuous Drain–Source I	•			-1.3	А
-	Drain–Source Diode Forward	$V_{GS} = 0 V$, $I_{S} = -1.3 A$ (Note 2)		-0.73	-1.2	V



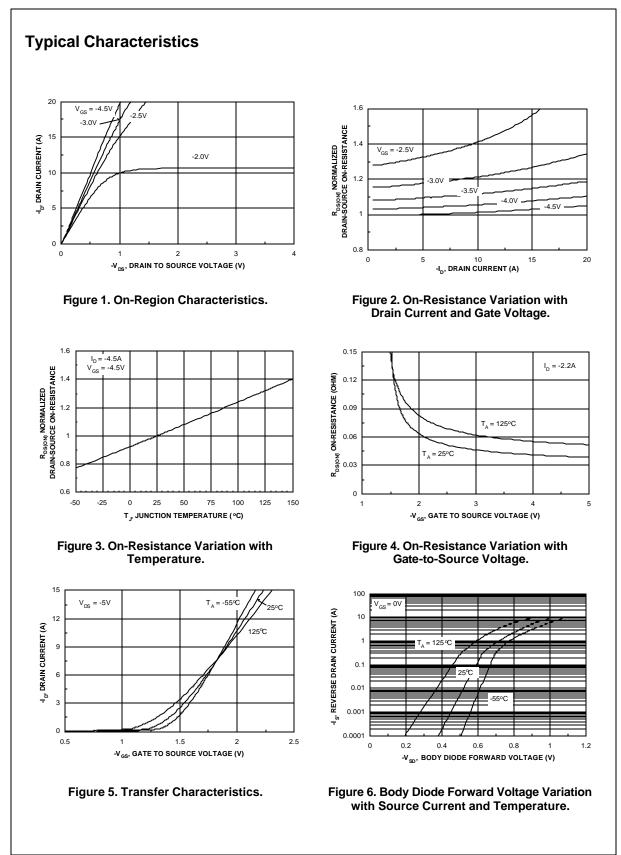
a) 78°C/W when mounted on a 1in² pad of 2 oz copper



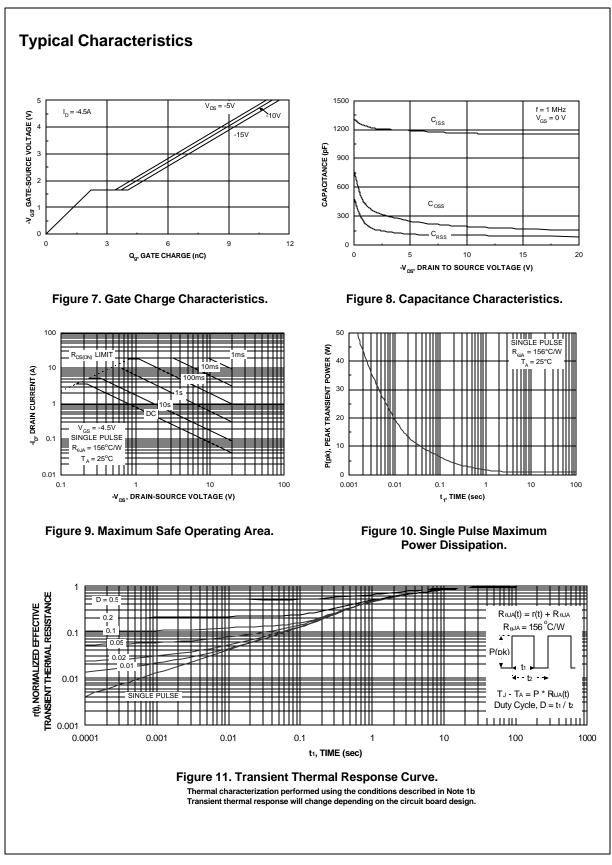
b) 156°C/W when mounted on a minimum pad of 2 oz copper

Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty Cycle < 2.0%

FDC638P Rev F (W)



FDC638P



FDC638P

FDC638P Rev F (W)

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General description

FDC638P

Single P-Channel 2.5V Specified PowerTrench MOSFET

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Analysis

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Design as

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Product status/pricing/packaging



Product	Product status	Pb-free Status	Pricing*	Package type	Leads	Packing method	Package Marking Convention**

Related Links

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How to order products

Product Change Notices (PCNs)

Support

Sales support

Quality and reliability

<u>Guanty and rendomity</u>

Design center

FET Bench .com

FDC638P	Full Production	Full Production	\$0.316	<u>SSOT-6</u>	6	Line 1: &E& Y (Binary Calendar Year Coding) Line 2: .638
FDC638P_NF073	Full Production	Full Production	N/A	<u>SSOT-6</u>	6	Line 1: &E& Y (Binary Calendar Year Coding) Line 2: .638

* Fairchild 1,000 piece Budgetary Pricing ** A sample button will appear if the part is available through Fairchild's on-line samples program. If there is no sample button, please contact a <u>Fairchild distributor</u> to obtain samples

Ø Indicates product with Pb-free second-level interconnect. For more information click here.

Package marking information for product FDC638P is available. Click here for more information .

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Models

Package & leads Condition Temperature range			Software version	Revision date		
PSPICE						
SSOT-6-6 Electrical 25°C to 125°C Orcad 9.1 Jan 23, 2001						

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Qualification Support

Click on a product for detailed qualification data

Product						
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